

## Contents

1	Introduction.....	2
2	Failure Conditions .....	2
	2.1. Solution.....	2
	2.2. Solution Description and Technical Conditions.....	2
3	Related Documents.....	3
4	Document Revision History.....	4

## List of Figures

Figure 2.1	Schematic for Work-Around Circuit .....	3
------------	---	---

## List of Tables

Table 2.1	Register Configuration .....	3
-----------	------------------------------	---

## 1 Introduction

This document describes failure cases where the ZSC31050 I<sup>2</sup>C communication stops and the methods for restarting the communication again.

## 2 Failure Conditions

One of the conditions that could cause the ZSC31010 I<sup>2</sup>C interface to block communication on the I<sup>2</sup>C bus is if the master interrupts the communication without sending a stop condition. This can happen if there is an interruption in the microcontroller's supply.

The communication master microcontroller is supplied by a voltage in the range of 6V to 36V via a switching regulator. The ZSC31050 is also directly connected to this supply voltage via a JFET (e.g., BS169). If the supply voltage decreases to less than the 9V lower limit of the regulator, the microcontroller is switched off; however the ZSC31050, including the analog output, remains operational if the supply voltage remains within ZSC31050 specifications. If the supply voltage exceeds the 9V threshold again, the microcontroller will start communicating with the ZSC31050 again. In this case, the failure described above can occur; i.e., the ZSC31050 does not respond to I<sup>2</sup>C requests. Typically this happens only after the supply voltage has crossed the 9V threshold multiple times.

A comparable condition can occur during EMC tests with the same consequence of interrupting I<sup>2</sup>C communication.

### 2.1. Solution

Resetting the ZSC31050 is the recommended method for restarting I<sup>2</sup>C communication. This is done by switching the supply voltage (and therefore the I<sup>2</sup>C communication lines) off and then on. This procedure has no application restrictions.

A disadvantage of this procedure is that a highly complex circuitry solution is needed for powering off the supply voltage via a low-voltage controller as described in section 2.2. This work-a-round uses the VDD supply voltage instead of the analog supply voltage VDDA. This is especially needed in the non-ratiometric mode. This is a more cost-effective solution for resetting the ZSC31050.

Important: This application work-a-round is to be implemented by users at their own risk. IDT shall not be liable for any damages arising out of defects resulting from this work-a-round.

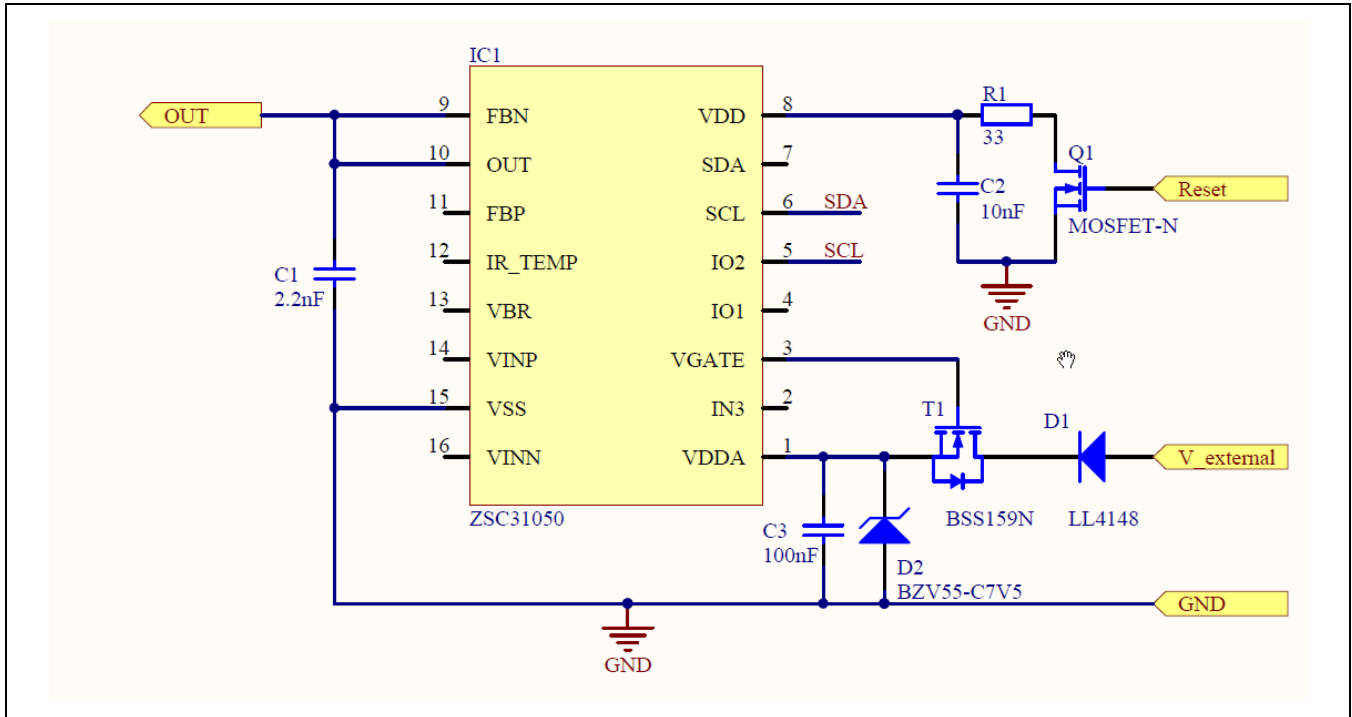
### 2.2. Solution Description and Technical Conditions

The reset is achieved by triggering a low-ohmic short from VDD to VSS via the circuit shown in Figure 2.1. The following conditions must be maintained during the procedure:

- The ambient temperature must be 25°C ± 15°C.
- The short resistor is R1=33Ω ± 10%.
- In absolute voltage output mode, the D2 Zener diode (V<sub>Z</sub> = 6.8V) is required between the VDDA and VSS pins.
- The maximum activation/reset signal time must be < 0.25ms.
- The duty-cycle of the reset signal must be < 1/10<sup>5</sup>.
- Important: Using the work-a-round in continuous operation is not allowed. This means that the reset should not be used as a systematically activated function for this application.

**Important:** Additional application circuitry as described in the *ZSC31050 Datasheet* might be necessary.

Figure 2.1 Schematic for the Work-Around Circuit



The registers shown in Table 2.1 can be used to set and fine-tune the regulation of the ZSC31050 supply voltage.

Table 2.1 Register Configuration

Settings	Register	Register Name	Bits	Comment
Supply Voltage VDDA	18 <sub>HEX</sub>	CFGAPP	[1:2]	Coarse regulation
Supply Voltage VDDA	1C <sub>HEX</sub>	ADJREF	[10:12]	Fine regulation

### 3 Related Documents

Visit the product page [www.idt.com/zsc31050](http://www.idt.com/zsc31050) on the IDT web site [www.idt.com](http://www.idt.com) or contact your nearest sales office for the latest version of these documents.

Document
ZSC31050 Data Sheet
ZSC31050 Functional Description
SSC Evaluation Kit Description

## 4 Document Revision History

Revision	Date	Description
1.00	April 28, 2008	First release.
2.00	September 12, 2013	Changed to ZMDI template.
160601	June 1, 2016	Changed to IDT branding. Minor edits.

## Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
  - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
  - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.
- Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
13. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
14. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.

(Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.

(Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Disclaimer Rev.5.0-1 October 2020)

## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

## Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

## Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:  
[www.renesas.com/contact/](http://www.renesas.com/contact/)